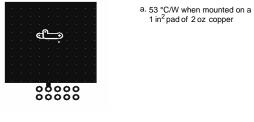


MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol		Parameter			Ratings	Units	
V _{DS}	Drain to \$	Drain to Source Voltage			100	V	
V _{GS}	Gate to S	Gate to Source Voltage			±20	V	
ID	Drain Cu	rrent -Continuous (Package lim	nited) $T_C = 25$	°C	20		
		-Continuous (Silicon limite	ed) T _C = 25	°C	29	•	
		-Continuous	T _A = 25	°C (Note 1a)	7	Α	
		-Pulsed			30		
E _{AS}	Single Pu	Ilse Avalanche Energy		(Note 3)	72	mJ	
P _D	Power Di	ssipation	T _C = 25	°C	41	w	
	Power Di	ssipation	T _A = 25	°C (Note 1a)	2.3	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C		
Thermal Ch _{R_{θJC}}		stics Resistance, Junction to Case			3		
R _{0JA}	Thermal Resistance, Junction to Ambient (Note 1a)			53	°C/W		
Package Ma	arking ar	d Ordering Information					
Device Ma	arking	Device	Package	Reel Size	Tape Width	Quantity	
FDMC86102		FDMC86102	Power 33	13"	12 mm	3000 units	

FDMC86102 N	
V-Channel	
Power Trenc	
h® N)
NOSFET	

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		69		mV/°0
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2.0	3.1	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-9		mV/°0
r _{DS(on)}		V _{GS} = 10 V, I _D = 7 A		19.4	24	
	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 5 A$		26.8	38	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$		32.8	41	
9 _{FS}	Forward Transconductance	$V_{DD} = 10 \text{ V}, \ \text{I}_{D} = 7 \text{ A}$		19		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 50 V, V _{GS} = 0 V,		725	965	pF
C _{oss}	Output Capacitance	$v_{\text{DS}} = 50 \text{ V}, v_{\text{GS}} = 0 \text{ V},$ 		175	235	pF
C _{rss}	Reverse Transfer Capacitance			15	25	pF
Rg	Gate Resistance			0.5		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 50 V, I _D = 7 A,		8	17	ns
t _r	Rise Time			4	10	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		14	25	ns
t _f	Fall Time			4	10	ns
0 (707)	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		13	18	nC
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 50 V$		8	11	nC
Q _{gs}	Total Gate Charge	I _D = 7 A		3.7		nC
Q _{gd}	Gate to Drain "Miller" Charge			3.6		nC
Drain-Sou	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 7 A$ (Note 2)		0.81	1.3	v
		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.75	1.2	
t _{rr}	Reverse Recovery Time	I _F = 7 A, di/dt = 100 A/μs		44	70	ns
Q _{rr}	Reverse Recovery Charge			40	65	nC

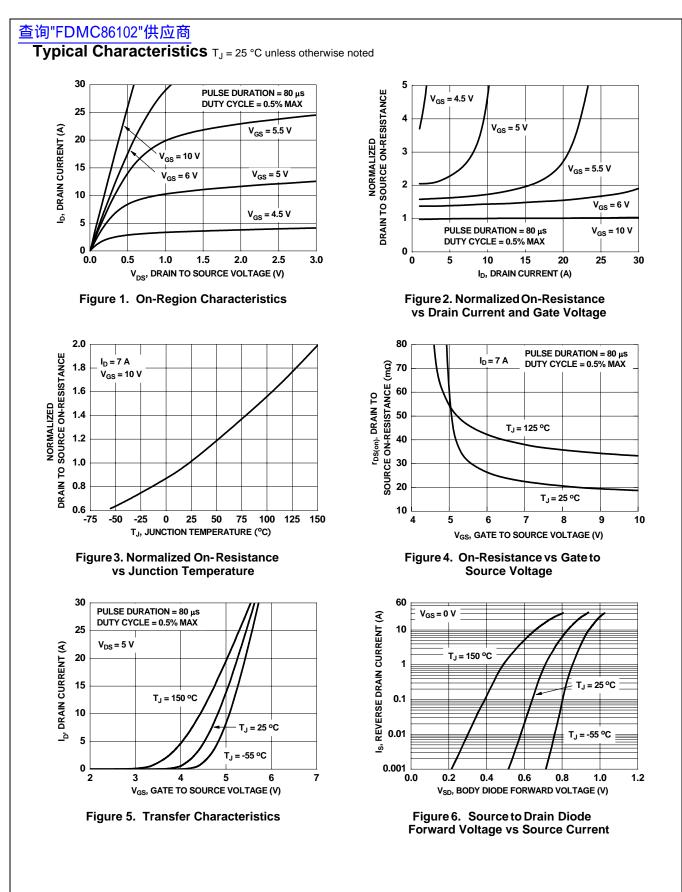


b. 125 °C/W when mounted on a minimum pad of 2 oz copper



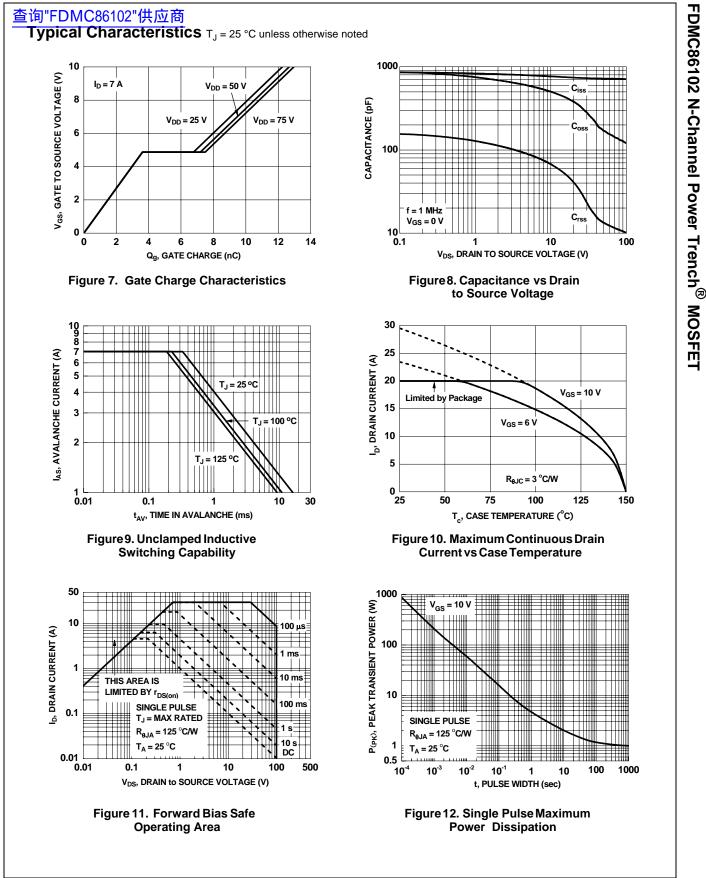
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

3. Starting T_J = 25 $^{o}C;$ N-ch: L = 1 mH, I_{AS} = 12 A, V_{DD} = 90 V, V_{GS} = 10 V.



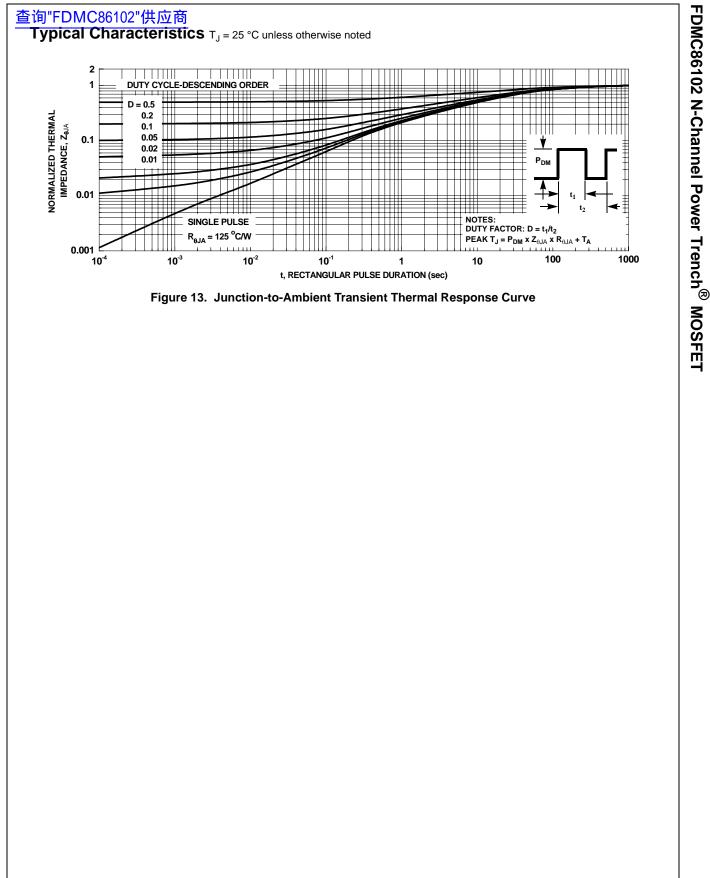
FDMC86102 Rev.C

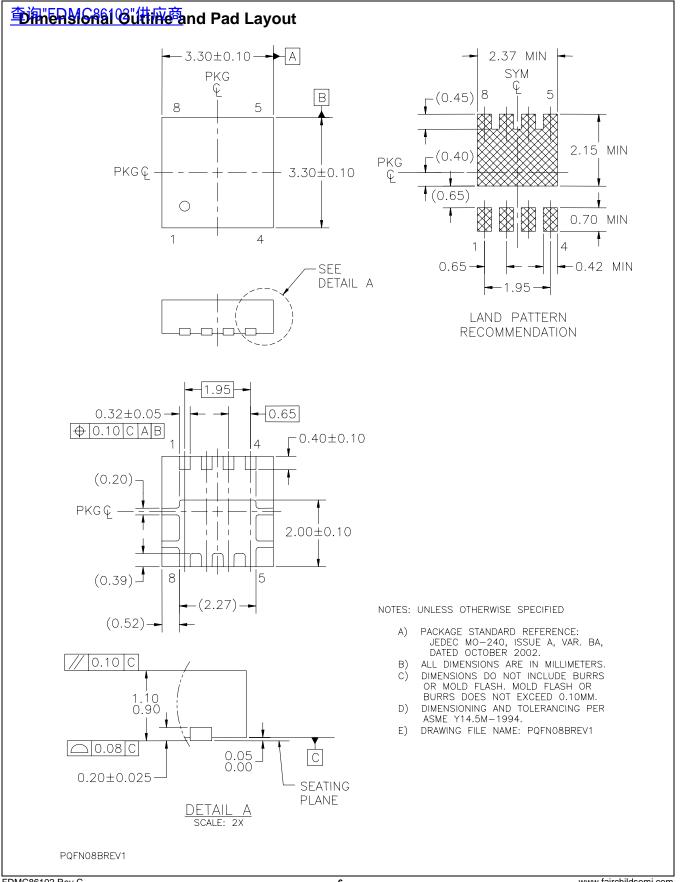
www.fairchildsemi.com



FDMC86102 Rev.C

4





FDMC86102 Rev.C

FDMC86102 N-Channel Power Trench[®] MOSFET

查询"FDMC86102"供应商

FAIRCHILD

SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

Auto-SPM TM Build it Now TM CorePLUS TM CorePOWER TM CroePOWER TM CTL TM CTL TM CUrrent Transfer Logic TM EcoSPARK [®] EfficentMax TM EZSWITCH TM * $\overrightarrow{Fairchild}^{\mathbb{B}}$ Fairchild Semiconductor [®] FACT Quiet Series TM FACT [®]	F-PFSTM FRFET® Global Power Resource SM Green FPSTM Green FPSTM e-SeriesTM GTOTM IntelliMAXTM ISOPLANARTM ME3BUckTM MICROCOUPLERTM MicroFETTM MicroFETTM MicroPakTM MillerDriveTM Motion-SPMTM OPTOLOGIC® OPTOPLANAR®	PowerTrench [®] PowerXS [™] Programmable Active Droop [™] QFET [®] QS [™] Quiet Series [™] RapidConfigure [™] \bigcirc \bigcirc ™ Saving our world, 1mW /W /kW at a time [™] SmartMax [™] SMART START [™] SMART START [™] SPM [®] STEALTH [™] SuperFET [™] SuperSOT [™] -3 SuperSOT [™] -6 SuperSOT [™] -8	The Power Franchise® pranchise TinyBoost TM TinyBouck TM TinyLogic® TINYOPTO TM TinyPower TM TinyPower TM TinyPWM TM TinyPWM TM TriFault Detect TM TRUECURRENT TM * µSerDes TM UHC® Ultra FRFET TM
Fairchild®	MotionMax [™]	SuperFET™	\mathcal{M}
FACT [®] FAST [®]	OPTOLOGIC®	SuperSOT™-6 SuperSOT™-8 SupreMOS™	UHC [®] Ultra FRFET™ UniFET™
FastvCore™ FETBench™ FlashWriter [®] * FPS™	PDP SPM™ Power-SPM™	SyncFET™ Sync-Lock™ SYSTEM ^{®*}	VCX™ VisualMax™ XS™
*Trademarks of System General Corp	poration, used under license by Fairchild		

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS. SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- 1 Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2 A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS **Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed Full Production Dim m		Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
		Re